ICPE 2@23-ECCE Pois

Green World with Power Electronics

The 11th
International Conference on
Power Electronics – ECCE Asia
(ICPE 2023-ECCE Asia)

May 22 (Mon.) – 25 (Thu.), 2023 ICC Jeju, Jeju, Korea

Industry Exhibition Prospectus



Organizer



Co-Sponsor

















Invitation

Dear Prospective Exhibitors,

The Organizing Committee of the 11th International Conference on Power Electronics – ECCE Asia (ICPE 2023-ECCE Asia), to be held in Jeju, Korea from May 22 to 25, 2023, cordially invites you to join an exhibitor in the event. The ICPE series, considered as the "Olympics of Power Electronic Experts," has become the world's premier event presenting the most recent developments and innovations in the fields of power electronics. The Korean Institute of Power Electronics (KIPE) is delighted to organize the ICPE 2023-ECCE Asia and will go to great lengths to ensure that the conference surpasses all expectations.

Under the theme of "Green World with Power Electronics" the comprehensive scientific and cutting-edge technical programs we have planned will provide exceptional opportunities for exhibition for you to build your brand and grow your business in the rapidly expanding power electronics market and beyond. In addition to more than 1,000 industrial, academic, and research experts attending from over 30 countries around the world, you, as an exhibitor, will gain direct access to international and local companies and professionals that are increasingly looking abroad for new and innovative geosynthetics products and solutions.

Exhibitors are essential and key partners to the conference, demonstrating equipment and expertise to the conference's strength and educational value. Power electronics professionals from all around the globe reply on your knowledge, aptitude and hands-on product demonstrations. It is a wonderful opportunity to share the knowledge and expertise with these power electronics specialists.

I am very confident that your participation in the conference will be a profitable investment for your business.

As one of the most dynamic countries in the world, Korean culture and infrastructure will also offer an attractive setting to inspire a highly successful ICPE 2023-ECCE Asia. Moreover, the beautiful island, Jeju, with its fascinating contrast of ancient architecture and ultramodern lifestyle, will be the perfect host city for this milestone in ICPE history.

I am looking forward to welcoming you in Jeju, Korea!

Sincerely,

Dong-Choon LeeGeneral Chair of ICPE 2023-ECCE Asia
Prof., Yeungnam University, Korea



Conference Overview

11th International Conference on Power Electronics – ECCE Asia Title

(ICPE 2023-ECCE Asia)

May 22 - 25, 2023 **Date**

Venue ICC Jeju, Jeju, Korea

Organizer The Korean Institute of Power Electronics (KIPE)

Co-Sponsor IEEE PELS (IEEE Power Electronics Society)

ECCE-Asia CES (China Electrotechnical Society)

Cooperation IEEJ-IAS (The Institute of Electrical Engineers of Japan)

Technical IEEE-IAS (IEEE Industry Applications Society)

EPE Association (European Power Electronics and Drives Association)

PEMC Council (International Power Electronics and Motion Control Conference

and Exposition)

Theme Green World with Power Electronics

Programs Opening / Closing Ceremony, Plenary Talks, Oral/Poster Session,

Welcome Reception, Banquet, Technical Tour, etc.

Expected About 1,000 attendees from over 30 countries **Attendance**

40 booths from over 30 companies

Official English Language

Co-Sponsor

Website www.icpe-conf.org

Important Digest Submission Deadline: November 14, 2022 **Dates**

Notification of Acceptance: January 9, 2023

Exhibition Application Deadline: February 28, 2023

Early Registration Deadline: April 7, 2023

Secretariat ICPE 2023-ECCE Asia Secretariat

Planex Lab. Inc. (PCO)

#703, 245, Hannuri-daero, Sejong-si, 30127, Republic of Korea

Tel.: +82-44-862-7962 / Fax.: +82-44-862-7963

E-mail: icpe@icpe-conf.org / Website: icpe@icpe-conf.org

Program

Time	May 22 (Mon.)	May 23 (Tue.)	May 24 (Wed.)	May 25 (Thu.)	
08:30~09:00 09:00~09:30 09:30~10:00 10:00~10:30		Oral Session I	Oral Session IV	Oral Session VII	
10:30~11:00	Tutorials	Coffee Break	Coffee Break	Coffee Break	
11:00~11:30		Opening Ceremony	Plenary Talk III	Plenary Talk III	
11:30~12:00		Plenary Talk I	Plenary Talk IV	Diaman, Tall, IV	
12:00~12:30		Plenary Talk II	I IGHALY TAIK IV	Plenary Talk IV	
12:30~13:00	Lunch	Lunch	Lunch	Lunch	
13:00~13:30					
13:30~14:00			Poster Session I	Poster Session II	
14:00~14:30				Oral Session VIII	
14:30~15:00		Oral Session II			
15:00~15:30	Tutorials		Oral Session V		
15:30~16:00		Coffee Break			
16:00~16:30			Coffee Break	Coffee Break	
16:30~17:00		Oral Session III			
17:00~17:30			Oral Session VI	Oral Session IX	
17:30~18:00					
18:00~18:30					
18:30~19:00					
19:00~19:30	Welcome Reception	alcome Recention			
19:30~20:00	. Totalina Hosopusii		Banquet		
20:00~20:30			·	Night of Jeju	
20:30~21:00					

Committee

General Chair

Dong-Choon Lee (Yeungnam University, Korea)

General Co-chair

Liuchen Chang (University of New Brunswick, Canada)

Organizing Committee

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Vice-chairs	Honnyong Cha (Kyungpook National University, Korea)
	Sungwoo Bae (Hanyang University, Korea)
	Jong-pil Lee (Korea Electrotechnology Research Institute, Korea)
	Kyung-Hee Han (Halla University, Korea)
	Jonghoon Kim (Chungnam National University, Korea)
	Sung-Jin Choi (University of Ulsan, Korea)

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	Axel Mertens (Leibniz University Hannover, Germany)
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	Jung-lk Ha (Seoul National University, Korea)
	Kyo-Beum Lee (Ajou University, Korea)
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	Rae-Young Kim (Hanyang University, Korea)
	Young-Doo Yoon (Hanyang University, Korea)
	Younghoon Cho (Konkuk University, Korea)

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International Steering Committee

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Dehong Xu (Zhejiang University, China)
Dianguo Xu (Harbin Institute of Technology, China)
Zhengming Zhao (Tsinghua University, China)

Exhibition Information

An extensive technical exhibition will take place during the three-day conference in BEXCO, Busan. The exhibition is expecting participation of about 1,000 subscribers and over 30 companies from around world and will offer optimal marketing opportunities for increased exposure and market expansion. The standard booth is a $3m \times 2m$ shell scheme and can be purchased in multiples of 6 square meters.

Place	Lobby (3F), ICC Jeju
Period	May 22-25, 2023
Exhibition Fee (10% VAT will be added)	KRW 3,500,000 (1EA) KRW 6,000,000 (2EA) / KRW 8,000,000 (3EA)

Exhibition Period

Activity	Date	Time
Exhibition Hall Setup	May 21, 2023	09:00~
Move-in	May 22, 2023	10:00~
Exhibition	May 23-25, 2023	09:00~18:00
Dismantling	May 25, 2023	18:00~

Booth Information

- White wall modules fitted into aluminum stand system
- Fascia board with company / organization name in standard letter
- Electrical supply for lighting (220V 1kW)
- Fluorescent lights
- 1 reception desk and 1 folding chair
- 1 electric outlet (2-hole)







Exhibitor Compensation

ICPE 2023-ECCE Asia offers exhibitors the following compensations per booth:

- 1 complimentary registration including 1 conference kit
- · Company logo on signage in the exhibition area
- Acknowledgement in the program book

Exhibit Space Rental Fees Not Included;

Furniture, telephone services, transportation, warehousing before and after the conference, customs brokerage, janitorial services in the booth as well as in the general exhibition area, special materials or furnishings, the moving, transfer, set up and dismantling of equipment or booths and lift services. Placing of carpets is obligatory in all exhibition spaces. Purchasing of these items and services is at the exhibitor's expense.

Application Procedure

- 1. Please fill out the exhibition application form.
- 2. E-mail it to the secretariat (icpe@icpe-conf.org) along with a copy of your business license.

Booth Assignment

The organizer shall allocate the space in accordance with the order of application, size of the space applied for, the nature of the exhibits or in the manner the organizer deems fit.

Payment Method

By Bank Transfer

- Account Holder: The Korean Institute of Power Electronics
- Account Number: 1010-2113-5525 Bank Name: SuHyup-bank
- Swift Code: NFFCKRSE Address: 62, Ogeum-ro, Songpa-Gu, Seoul, 05510, South Korea.

Exhibition Application

• ICPE 2023-ECCE Asia Secretariat

Planex Lab. (PCO) Tel.: +82-44-862-7962 / Fax.: +82-44-862-7963 / E-mail: icpe@icpe-conf.org

1. Applicant Information

• Company Name			
• President/CEO			
Postal Address		Zip code ()
• Contact Person	• Position		
Telephone	• Fax		
• E-mail	• Website		

2. Exhibition Application

Booth Number(s)	Rates (Unit: KRW, 10% VAT will be added)	Application
1	3,500,000	
2	6,000,000	
3	8,000,000	

^{*} Please select the desired number of booths and fill in the application.

3. Payment

Upon submission of this form, the secretariat will send you a detailed invoice, including taxes and payment terms. Payment should be made to the ICPE 2023-ECCE Asia by bank transfer with the completed application form. Please make use of the information below. (*All bank charges should be borne by the company.)

- Account Holder: The Korean Institute of Power Electronics

- Account Number: 1010-2113-5525

- Bank Name: SuHyup-bank - Swift Code: NFFCKRSE

- Address: 62, Ogeum-ro, Songpa-Gu, Seoul, 05510, South Korea

Name of Applicant:	Date:	
Signature:		



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